

**USJ60R600Z**

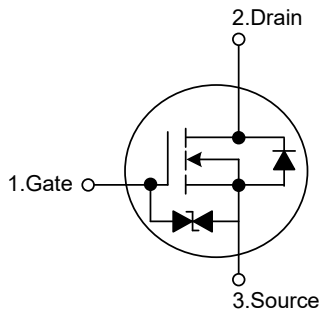
Preliminary

Power MOSFET**9.0A, 600V N-CHANNEL
SUPER-JUNCTION MOSFET****DESCRIPTION**

The **UTC USJ60R600Z** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

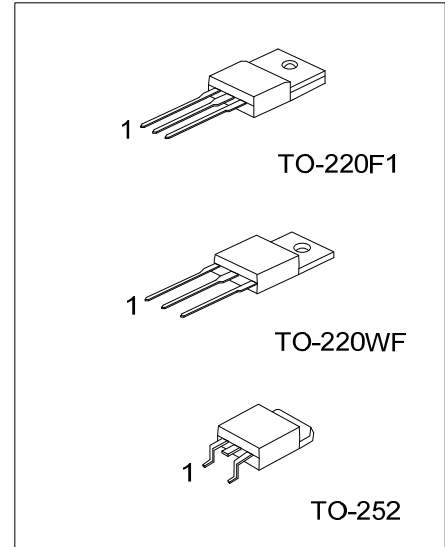
- * $R_{DS(ON)} \leq 0.6 \Omega$ @ $V_{GS}=10V$, $I_D=2.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness
- * With ESD protection

SYMBOL**ORDERING INFORMATION**

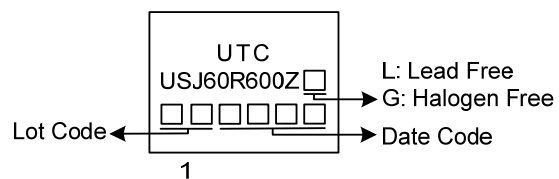
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
USJ60R600ZL-TF1-T	USJ60R600ZG-TF1-T	TO-220F1	G	D	S	Tube
USJ60R600ZL-TW1-T	USJ60R600ZG-TW1-T	TO-220WF	G	D	S	Tube
USJ60R600ZL-TN3-R	USJ60R600ZG-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

USJ60R600ZG-TF1-T	(1) Packing Type	(1) T: Tube, R: Tape Reel
	(2) Package Type	(2) TF1: TO-220F1, TW1: TO-220WF, TN3: TO-252
	(3) Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free



■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	9	A
	Pulsed (Note 2)	I_{DM}	27	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	110	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.3	V/ns
Power Dissipation	TO-220F1/TO-220WF	P_D	28	W
	TO-252		54	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 100\text{mH}$, $I_{AS} = 1.5\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$ Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 9.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1/TO-220WF	θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
	TO-252		110	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220F1/TO-220WF	θ_{JC}	4.46	$^\circ\text{C}/\text{W}$
	TO-252		2.31 (Note)	$^\circ\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate P_c board, 2oz copper, with 1inch square copper plate.

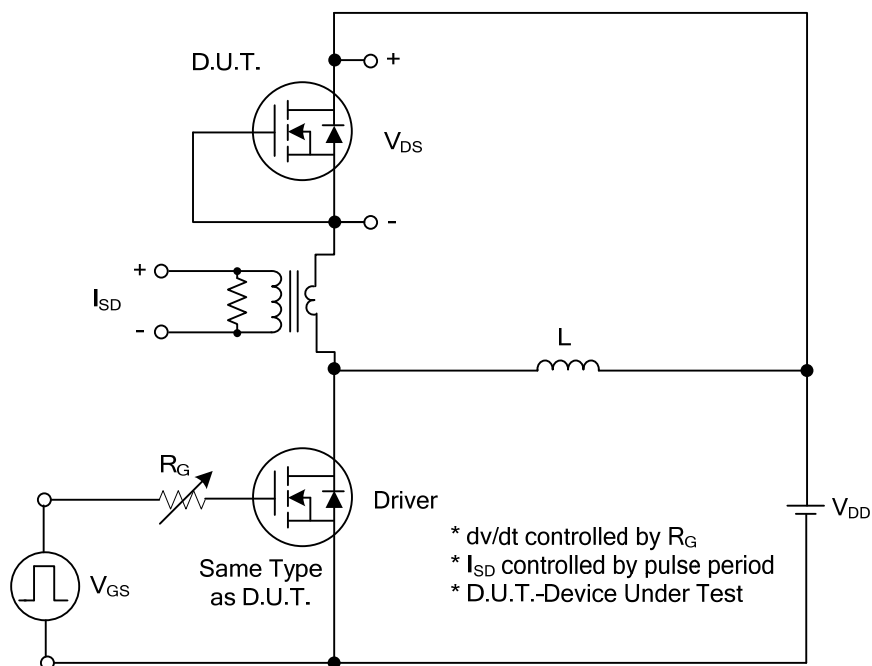
■ **ELECTRICAL CHARACTERISTICS** ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±10	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.5A			0.6	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =50V, f=1MHz		522		pF
Output Capacitance	C _{OSS}			85		pF
Reverse Transfer Capacitance	C _{RSS}			4		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q _G	V _{DS} =480V, V _{GS} =10V, I _D =1.0A (Note 1, 2)		22		nC
Gate-Source Charge	Q _{GS}			5.8		nC
Gate-Drain Charge	Q _{DD}			5.3		nC
Turn-On Delay Time (Note 1)	t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =3.25A, R _G =25Ω (Note 1, 2)		7		ns
Turn-On Rise Time	t _R			20		ns
Turn-Off Delay Time	t _{D(OFF)}			50		ns
Turn-Off Fall Time	t _F			32		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I _S				9	A
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =9.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =9.0A, V _{GS} =0V, dI _F /dt=100A/μs		220		nS
Body Diode Reverse Recovery Charge	Q _{rr}			1779		nC

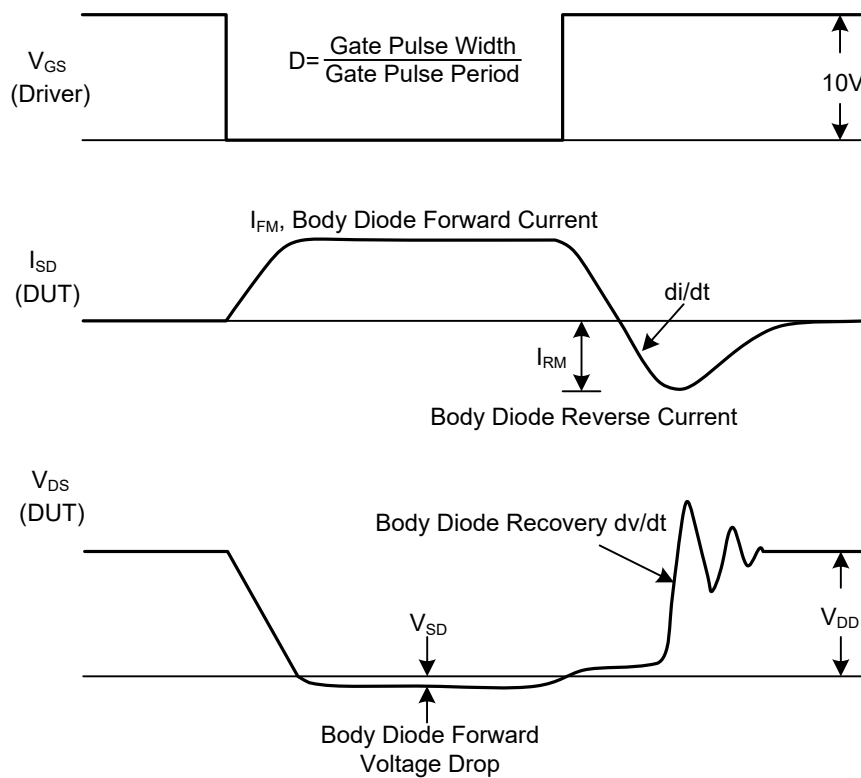
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

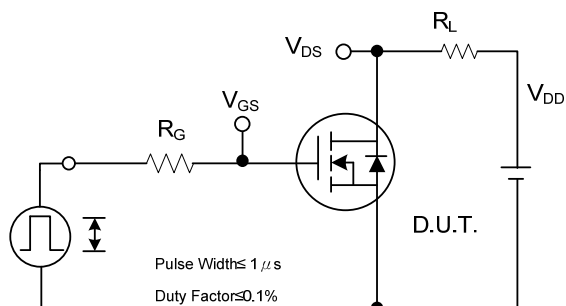


Peak Diode Recovery dv/dt Test Circuit

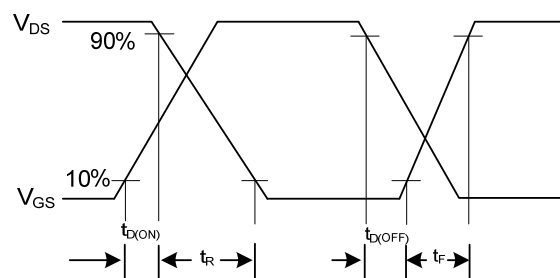


Peak Diode Recovery dv/dt Waveforms

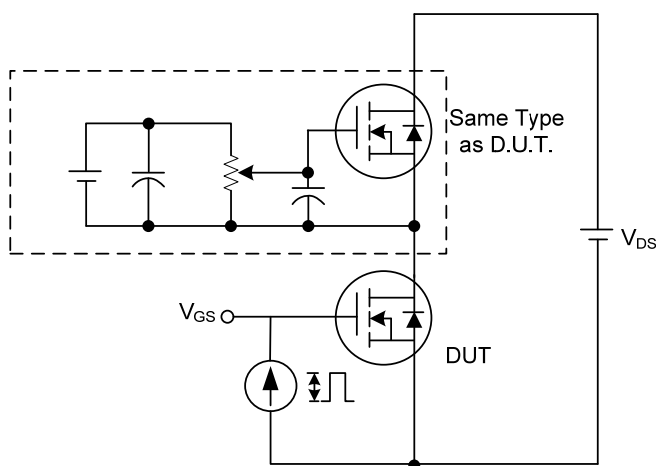
■ TEST CIRCUITS AND WAVEFORMS



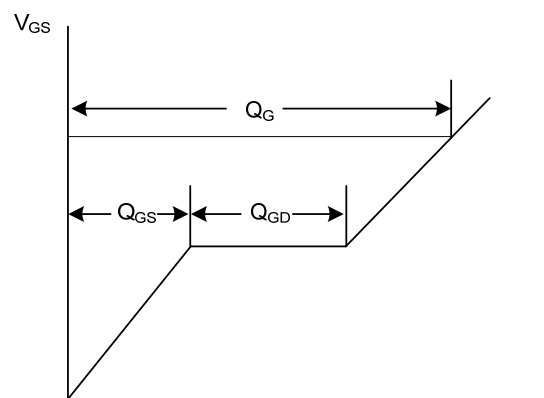
Switching Test Circuit



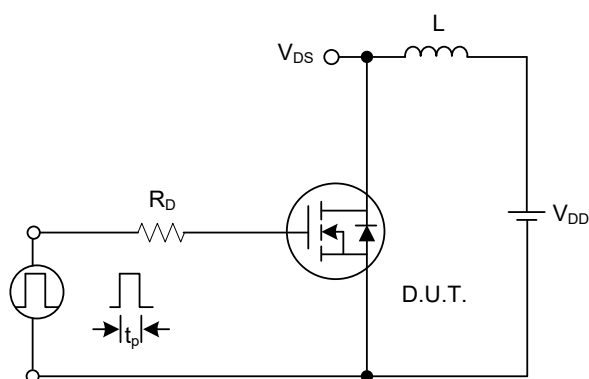
Switching Waveforms



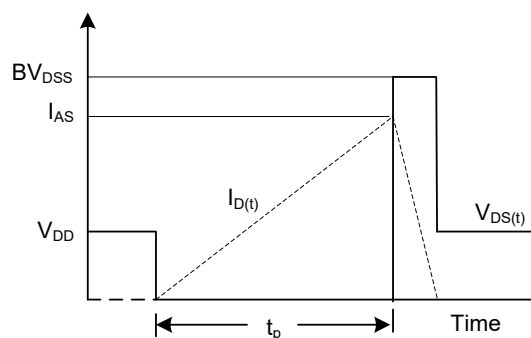
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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